# IGBT with Monolithic Free Wheeling Diode

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, provides superior performance in demanding switching applications, and offers low on–state voltage with minimal switching losses. The IGBT is well suited for resonant or soft switching applications.

#### Features

- Extremely Efficient Trench with Fieldstop Technology
- 1350 V Breakdown Voltage
- Optimized for Low Losses in IH Cooker Application
- Reliable and Cost Effective Single Die Solution
- These are Pb-Free Devices

#### **Typical Applications**

- Inductive Heating
- Consumer Appliances
- Soft Switching

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-emitter voltage @ T <sub>J</sub> = 25°C	V <sub>CES</sub>	1350	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι <sub>c</sub>	60 30	A
Pulsed collector current, T <sub>pulse</sub> limited by T <sub>Jmax</sub> 10 $\mu$ s pulse, V <sub>GE</sub> = 15 V	I <sub>CM</sub>	120	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	I <sub>F</sub>	60 30	A
Diode pulsed current, $T_{pulse}$ limited by $T_{Jmax}$ 10 $\mu s$ pulse, $V_{GE}$ = 0 V	I <sub>FM</sub>	120	A
Gate-emitter voltage Transient Gate-emitter Voltage ( $T_{pulse} = 5 \ \mu s, D < 0.10$ )	$V_{GE}$	±20 ±25	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P <sub>D</sub>	394 197	W
Operating junction temperature range	TJ	-40 to +175	°C
Storage temperature range	T <sub>stg</sub>	–55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T <sub>SLD</sub>	260	°C

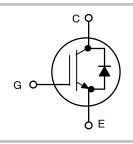
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

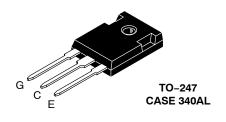


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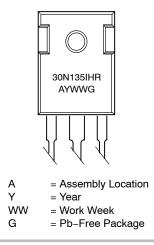
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30 A, 1350 V V<sub>CEsat</sub> = 2.30 V E<sub>off</sub> = 0.85 mJ





#### MARKING DIAGRAM



#### ORDERING INFORMATION

Device	Package	Shipping
NGTB30N135IHRWG	TO–247 (Pb–Free)	30 Units / Rail

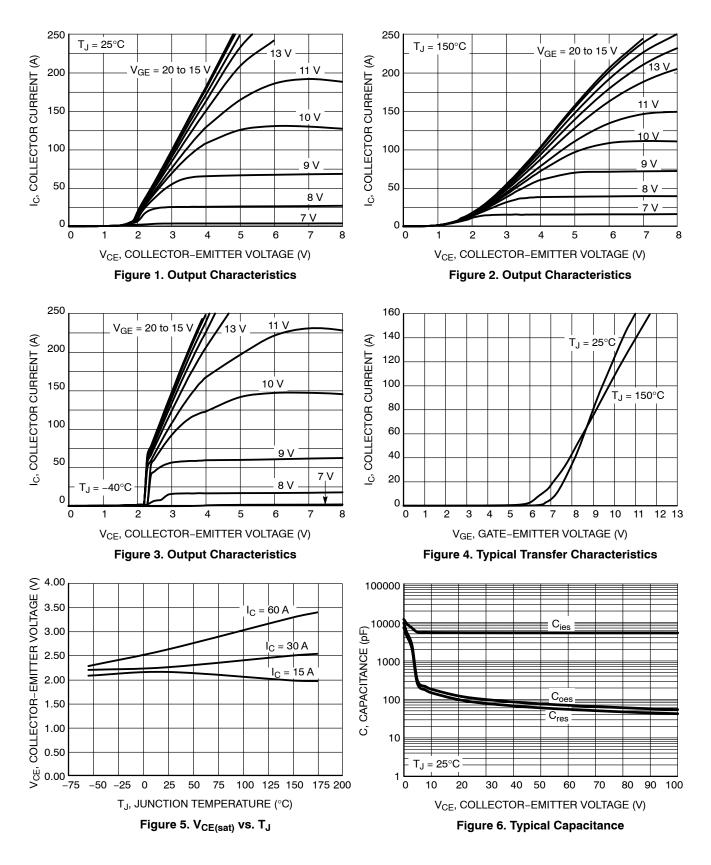
#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case	$R_{ ext{ heta}JC}$	0.38	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

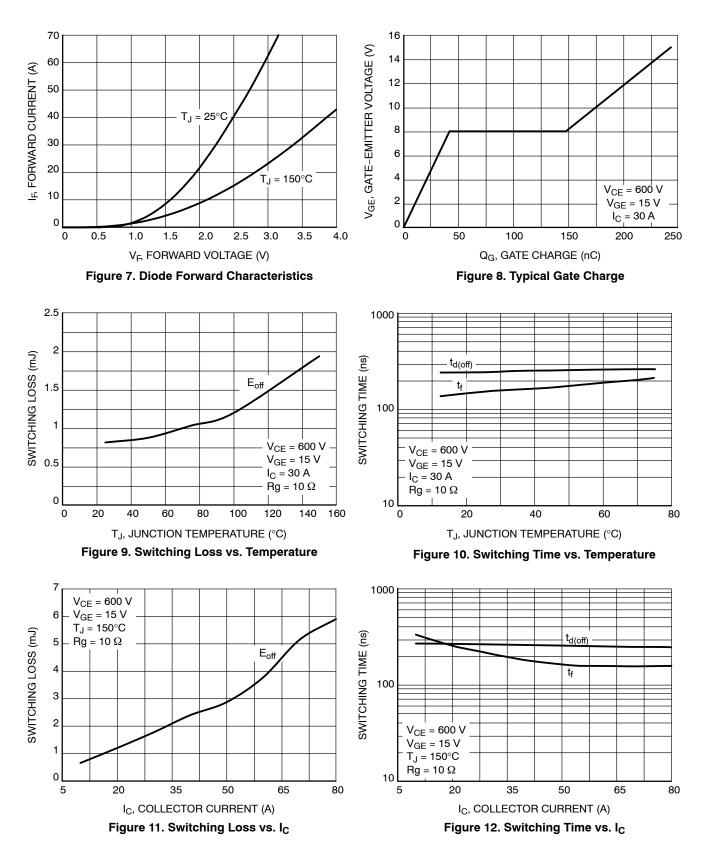
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•	•			•	
Collector-emitter breakdown voltage, gate-emitter short-circuited	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 5 mA	V <sub>(BR)CES</sub>	1350	-	_	V
Collector-emitter saturation voltage	$V_{GE}$ = 15 V, I <sub>C</sub> = 30 A V <sub>GE</sub> = 15 V, I <sub>C</sub> = 30 A, T <sub>J</sub> = 175°C	V <sub>CEsat</sub>	-	2.30 2.50	2.65 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 250 \ \mu A$	V <sub>GE(th)</sub>	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 1350 V$ $V_{GE} = 0 V, V_{CE} = 1350 V, T_{J=} 175^{\circ}C$	I <sub>CES</sub>		-	0.5 2.0	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE}$ = 20 V, $V_{CE}$ = 0 V	I <sub>GES</sub>	_	-	100	nA
DYNAMIC CHARACTERISTIC	·					
Input capacitance	V <sub>CE</sub> = 20 V, V <sub>GE</sub> = 0 V, f = 1 MHz	C <sub>ies</sub>	-	5290	-	pF
Output capacitance		C <sub>oes</sub>	-	124	-	
Reverse transfer capacitance		C <sub>res</sub>	-	100	-	
Gate charge total		Qg	-	234	-	nC
Gate to emitter charge	$V_{CE}$ = 600 V, I <sub>C</sub> = 30 A, V <sub>GE</sub> = 15 V	Q <sub>ge</sub>	-	39	-	
Gate to collector charge		Q <sub>gc</sub>	-	105	-	
SWITCHING CHARACTERISTIC, INDUCT						
Turn-off delay time	$\begin{array}{c} {T_{\rm J}} = 25^{\circ}{\rm C} \\ {V_{\rm CC}} = 600 \; {V,\; I_{\rm C}} = 30 \; {\rm A} \\ {R_{\rm g}} = 10 \; {\Omega} \\ {V_{\rm GE}} = 0 \; {V/} \; 15{\rm V} \end{array}$	t <sub>d(off)</sub>	-	250	-	ns
Fall time		t <sub>f</sub>	-	150	-	
Turn-off switching loss		E <sub>off</sub>	-	0.85	-	mJ
Turn-off delay time	T <sub>J</sub> = 150°C	t <sub>d(off)</sub>	-	265	-	ns
Fall time	$V_{CC} = 600 \text{ V, I}_{C} = 30 \text{ A}$ $R_g = 10 \Omega$ $V_{GE} = 0 \text{ V/ } 15 \text{ V}$	t <sub>f</sub>	-	225	_	
Turn–off switching loss		E <sub>off</sub>	-	1.90	-	mJ
DIODE CHARACTERISTIC						
Forward voltage	V <sub>GE</sub> = 0 V, I <sub>F</sub> = 30 A V <sub>GE</sub> = 0 V, I <sub>F</sub> = 30 A, T <sub>J</sub> = 175°C	V <sub>F</sub>	_	2.10 3.20	2.40 _	V

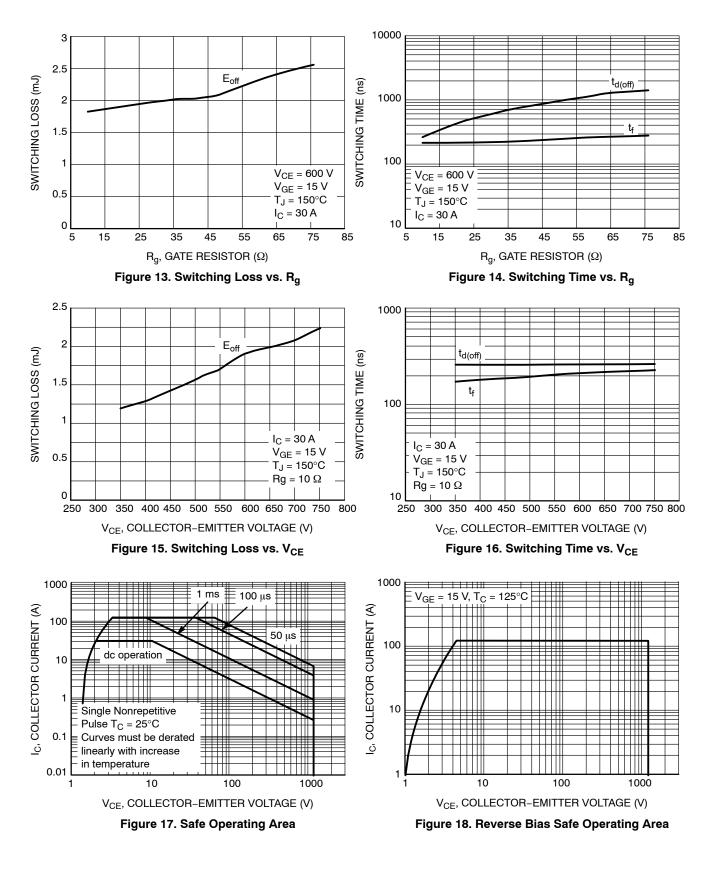
#### **TYPICAL CHARACTERISTICS**



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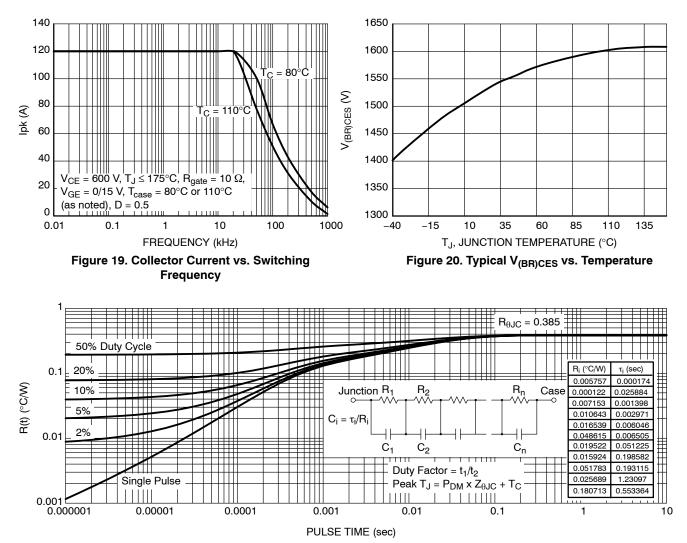


Figure 21. IGBT Transient Thermal Impedance

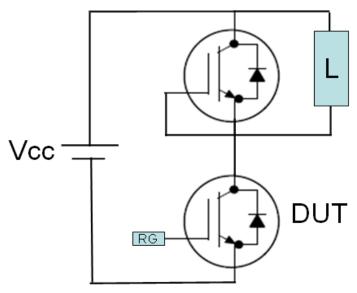
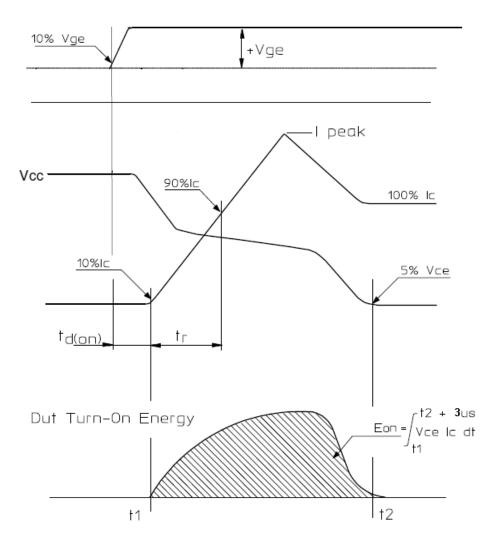
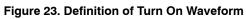
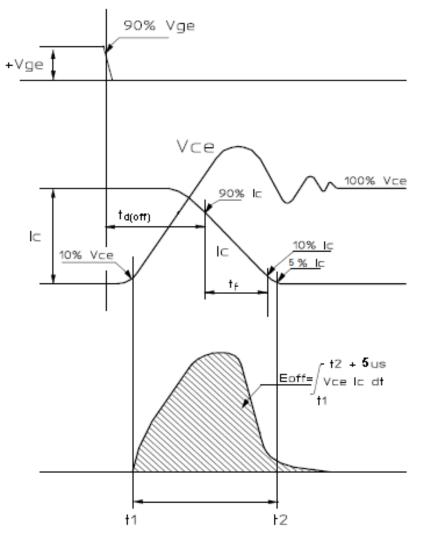
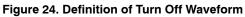


Figure 22. Test Circuit for Switching Characteristics





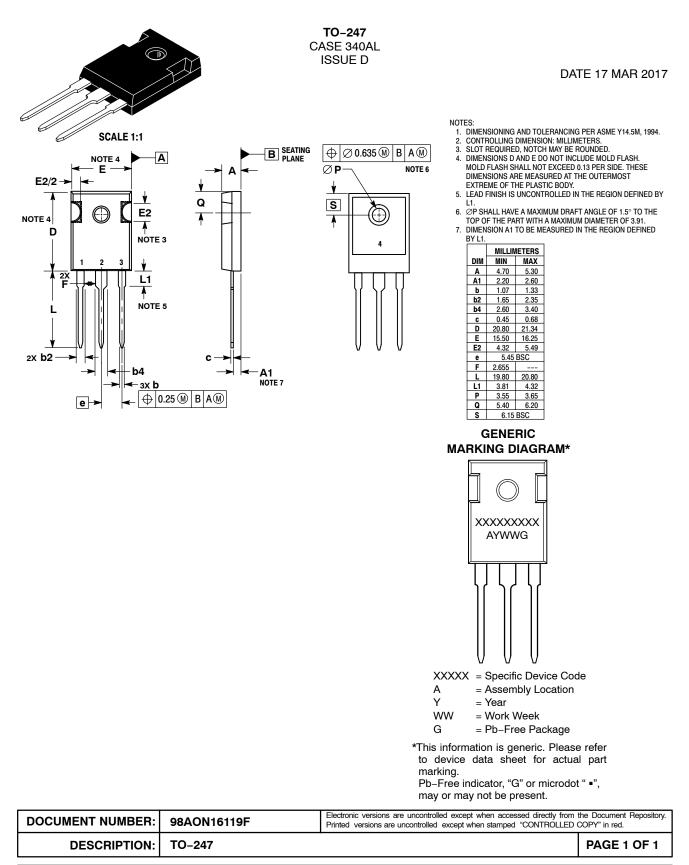




# **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS





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